IGBT - Ultra Field Stop

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Ultra Field Stop Trench construction, and provides superior performance in demanding switching applications, offering low switching losses. The IGBT is well suited for applications that require fast switching IGBT with low V_F diodes, e.g. phase–shifted full bridge, etc. Incorporated into the device is a free wheeling diode with a low forward voltage.

Features

- Extremely Efficient Trench with Field Stop Technology
- $T_{Jmax} = 175^{\circ}C$
- Low V_F Reverse Diode
- Optimized for High Speed Switching
- These are Pb–Free Devices

Typical Applications

- Welding
- Uninterruptible Power Inverter Supplies (UPS)
- Motor Control

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-emitter voltage	V _{CES}	1200	V
Collector current @ Tc = 25°C @ Tc = 100°C	Ι _C	160 40	A
Pulsed collector current, T _{pulse} limited by T _{Jmax}	I _{CM}	160	A
Diode forward current @ Tc = 25°C @ Tc = 100°C	IF	160 40	A
Diode pulsed current, T_{pulse} limited by T_{Jmax}	I _{FM}	160	A
Gate-emitter voltage Transient gate-emitter voltage $(T_{pulse} = 5 \ \mu s, D < 0.10)$	V _{GE}	±20 ±30	V
Power Dissipation @ Tc = 25°C @ Tc = 100°C	P _D	454 227	W
Operating junction temperature range	Τ _J	–55 to +175	°C
Storage temperature range	T _{stg}	–55 to +175	°C
Lead temperature for soldering, 1/8" from case for 10 seconds	T _{SLD}	260	°C

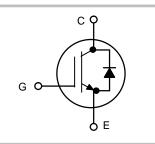
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

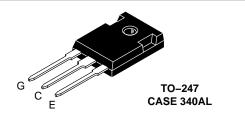


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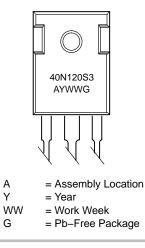
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40 A, 1200 V V_{CEsat} = 1.7 V E_{off} = 1.1 mJ





MARKING DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping
NGTB40N120S3WG	TO–247 (Pb–Free)	30 Units / Rail

THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{\theta JC}$	0.34	°C/W
Thermal resistance junction-to-case, for Diode	$R_{\theta JC}$	0.5	°C/W
Thermal resistance junction-to-ambient	$R_{\theta JA}$	40	°C/W

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
STATIC CHARACTERISTIC						
Collector-emitter breakdown voltage, gate-emitter short-circuited	V_{GE} = 0 V, I _C = 500 µA	V _{(BR)CES}	1200	-	-	V
Collector-emitter saturation voltage	V _{GE} = 15 V, I _C = 40 A V _{GE} = 15 V, I _C = 40 A, T _J = 175°C	V _{CEsat}		1.7 2.3	1.95 -	V
Gate-emitter threshold voltage	$V_{GE} = V_{CE}$, $I_C = 400 \ \mu A$	V _{GE(th)}	4.5	5.5	6.5	V
Collector-emitter cut-off current, gate- emitter short-circuited	$V_{GE} = 0 V$, $V_{CE} = 1200 V$ $V_{GE} = 0 V$, $V_{CE} = 1200 V$, $T_{J} = 175^{\circ}C$	ICES		_ 0.5	0.4 _	mA
Gate leakage current, collector-emitter short-circuited	V_{GE} = 20 V , V_{CE} = 0 V	I _{GES}	-	-	200	nA

Input capacitance		Cies	-	4912	-	pF
Output capacitance	V _{CE} = 20 V, V _{GE} = 0 V, f = 1 MHz	Coes	-	140	-	
Reverse transfer capacitance		C _{res}	-	80	-	
Gate charge total		Qg	-	212	-	nC
Gate to emitter charge	$V_{CE} = 600 \text{ V}, \text{ I}_{C} = 40 \text{ A}, \text{ V}_{GE} = 15 \text{ V}$	Q _{ge}	-	43	-	
Gate to collector charge		Q _{gc}	-	102	-	1

SWITCHING CHARACTERISTIC, INDUCTIVE LOAD

Turn-on delay time		t _{d(on)}	-	12	-	ns
Rise time		t _r	-	25	-	
Turn-off delay time	$T_J = 25^{\circ}C$	t _{d(off)}	-	145	-	
Fall time	$T_{J} = 25^{\circ}C$ $V_{CC} = 600 \text{ V, I}_{C} = 40 \text{ A}$ $R_{g} = 10 \Omega$ $V_{GE} = 15 \text{ V}$	t _f	-	107	-	
Turn-on switching loss	V _{GE} = 15V	Eon	-	2.2	-	mJ
Turn-off switching loss		E _{off}	-	1.1	-	
Total switching loss		E _{ts}	-	3.3	-	
Turn-on delay time		t _{d(on)}	-	13	-	ns
Rise time		t _r	-	24	-	
Turn-off delay time	$T_J = 175^{\circ}C$	t _{d(off)}	-	153	-	
Fall time	$T_{J} = 175^{\circ}C$ $V_{CC} = 600 \text{ V, }I_{C} = 40 \text{ A}$ $R_{g} = 10 \Omega$ $V_{GE} = 15 \text{ V}$	t _f	-	173	-	
Turn-on switching loss	V _{GE} = 15 V	Eon	-	2.8	-	mJ
Turn-off switching loss		E _{off}	-	1.6	-	1
Total switching loss		E _{ts}	-	4.4	-	1

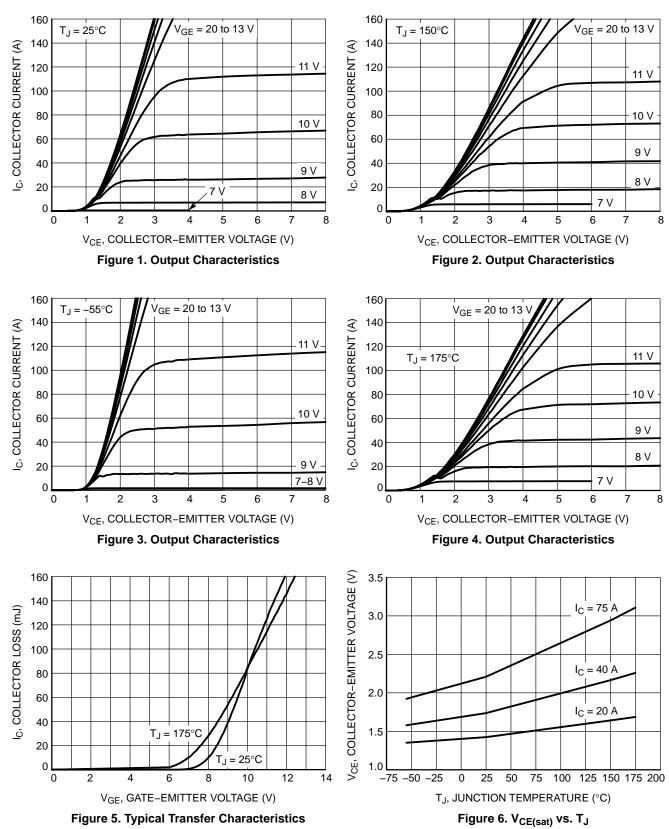
DIODE CHARACTERISTIC

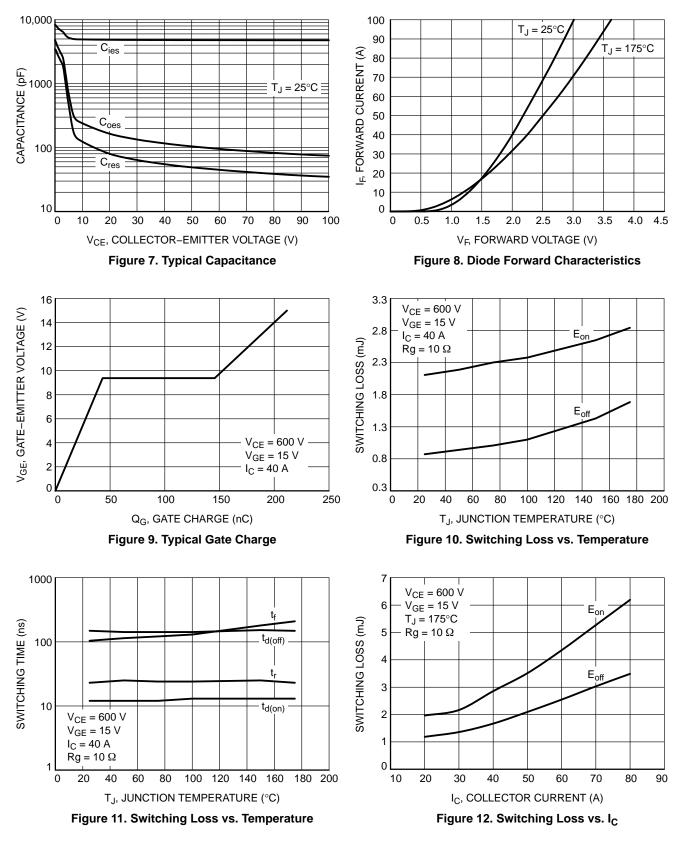
Forward voltage	$V_{GE} = 0 \text{ V}, \text{ I}_F = 40 \text{ A}$ $V_{GE} = 0 \text{ V}, \text{ I}_F = 40 \text{ A}, \text{ T}_J = 175^{\circ}\text{C}$	V _F		2.0 2.55	2.6	V
Reverse recovery time		t _{rr}	-	163	-	ns
Reverse recovery charge	T.I = 25°C	Q _{rr}	-	2.9	-	μC
Reverse recovery current	$I_F = 40 \text{ Å}, V_R = 400 \text{ V}$	I _{rrm}	-	30	-	А
Diode peak rate of fall of reverse recovery current during tb	di _F /dt = 500 A/µs	dl _{rrm} /dt	-	137	-	A/μs

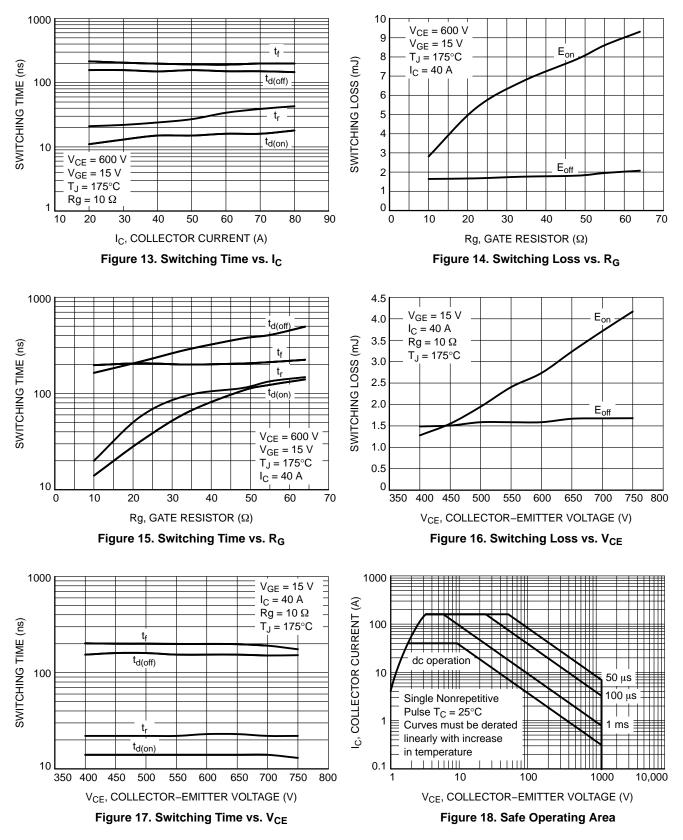
ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified)

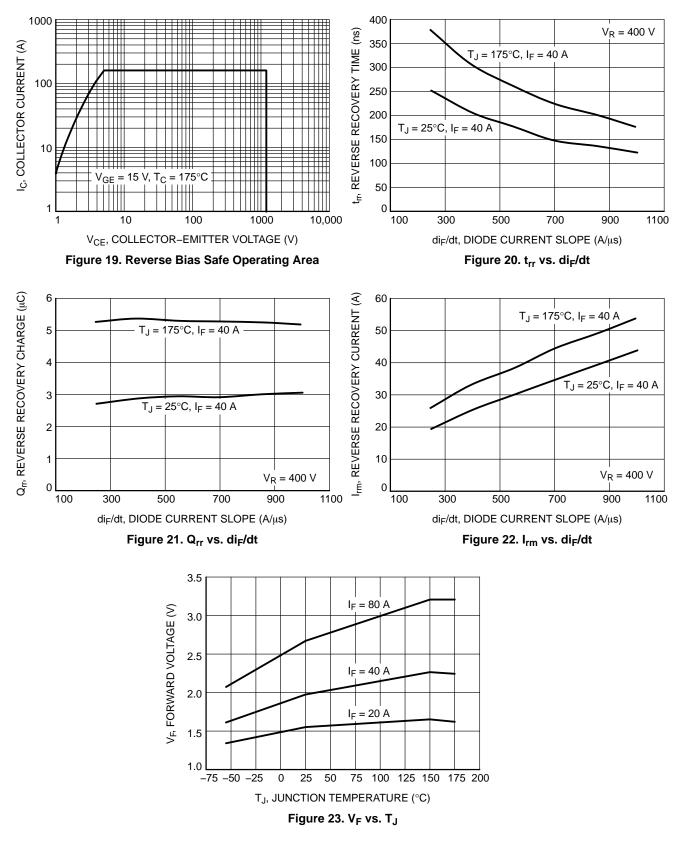
Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
DIODE CHARACTERISTIC						
Reverse recovery time	T _J = 175°C I _F = 40 A, V _R = 400 V	t _{rr}	_	250	-	ns
Reverse recovery charge		Q _{rr}	-	5.3	-	μC
Reverse recovery current		I _{rrm}	-	40	-	А
Diode peak rate of fall of reverse recovery current during tb	di _F /dt = 500 A/µs	dl _{rrm} /dt	-	482	-	A/μs

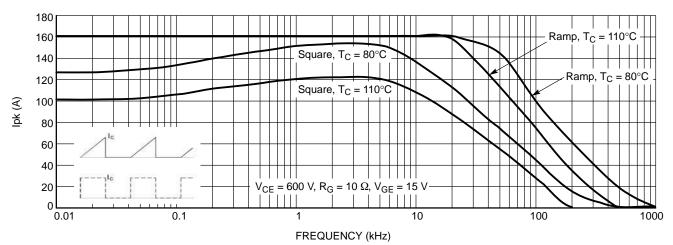
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.



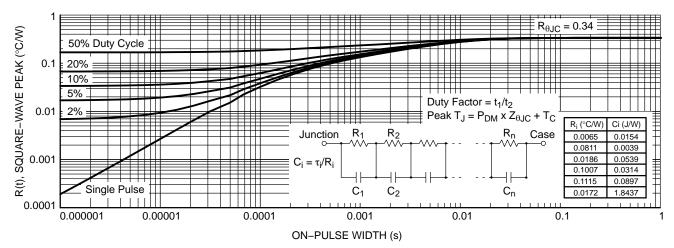




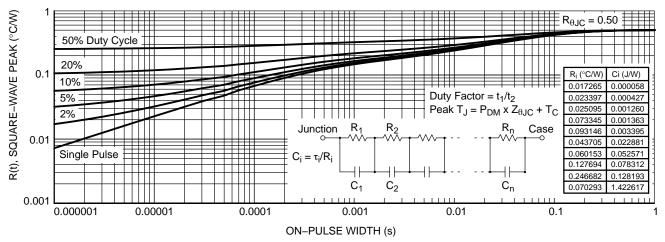














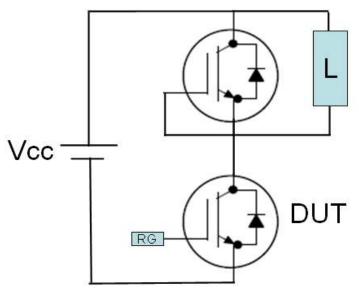


Figure 27. Test Circuit for Switching Characteristics

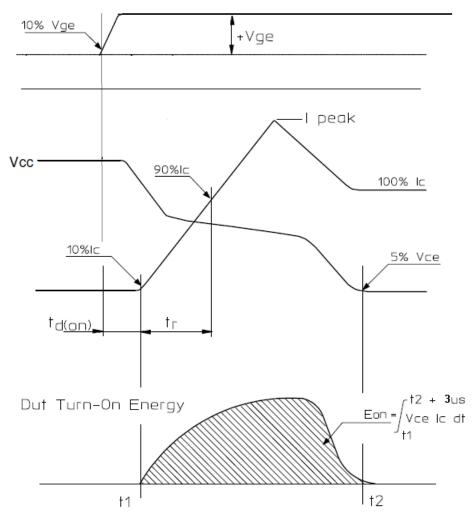
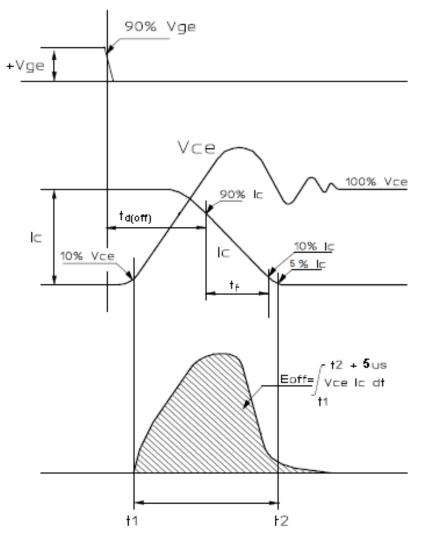
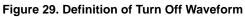


Figure 28. Definition of Turn On Waveform

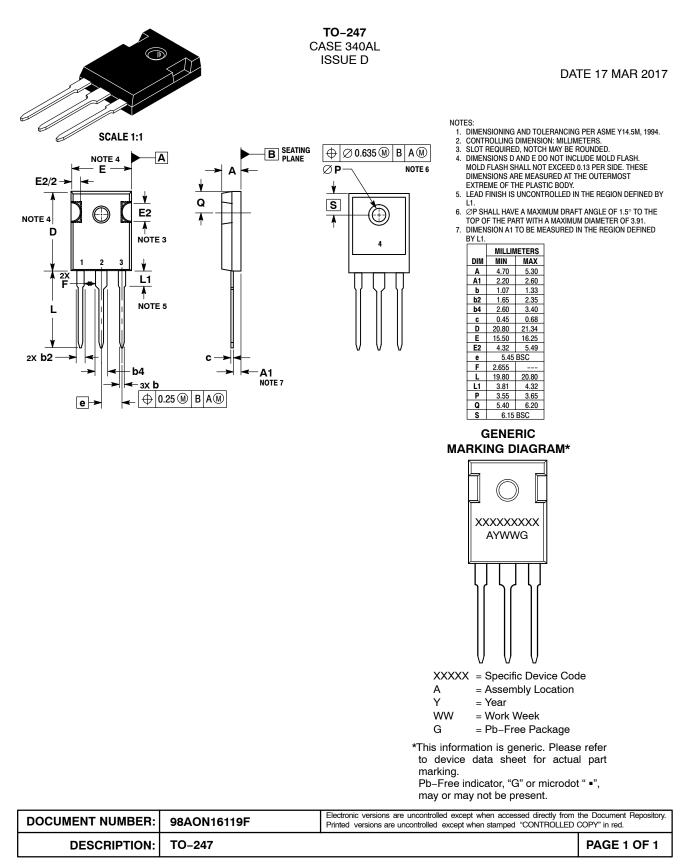




MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS





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